or 2, wherein the heat conduction analysis determines the material, the placement position and the shape of the ~~range~~ heat-insulating layer.

4. The method for manufacturing a mold according to any one of claims 1 to 3, wherein the heat-insulating layer has a thermal conductivity of 0.3 W/m·K or less and a thickness of 60 μm or more.

5. The method for manufacturing a mold according to any one of claims 1 to 4, wherein the heat-insulating layer contains at least one resin selected from polybenzoimidazole, polyimide and polyether ether ketone.

6. The method for manufacturing a mold according to any one of claims 1 to 4, wherein the heat-insulating layer is a ceramic material constituted by porous zirconia.

7. The method for manufacturing a mold according to any one of claims 1 to 5, wherein the heat-insulating layer has a metal layer on the surface.